

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6679719

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FUMIYUKI KAWASE	03/18/2021
DAIJI KONDO	03/18/2021
RECEIVING PARTY DATA	
Name:	PACIFIC ENGINEERING CORPORATION
Street Address:	450 HINOKI-CHO
Internal Address:	GIFU
City:	OGAKI-SHI
State/Country:	JAPAN
Postal Code:	5030981
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17289171
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	christopher.freerks@fisherbroyles.com
Correspondent Name:	FISHERBROYLES LLP
Address Line 1:	701 FIFTH AVENUE
Address Line 2:	SUITE 4200
Address Line 4:	SEATTLE, WASHINGTON 98104
ATTORNEY DOCKET NUMBER:	15380.004US1
NAME OF SUBMITTER:	KEVIN D JABLONSKI
SIGNATURE:	/Kevin D Jablonski/
DATE SIGNED:	04/27/2021
Total Attachments: 3	
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ASSIGNMENT

WHEREAS we, Fumiyuki Kawase and Daiji Kondo (hereinafter "ASSIGNORS"), are the joint inventors of the invention(s) disclosed in an application for United States letters patent entitled, "Substrate Surface-Mounted Fuse", which is filed concurrently herewith, which is a National Phase application based on international application No. PCT/JP2019/037786 filed September 26, 2019, and which claims the benefit of priority from Japanese patent application No. 2018-220127 filed November 26, 2018; and

WHEREAS, Pacific Engineering Corporation (hereinafter "ASSIGNEE"), a juristic entity of Japan, having a principle place of business at 450 Hinoki-cho, Ogaki-Shi, Gifu 5030981, Japan, is desirous of acquiring the entire right, title, and interest in and to the invention(s), application(s), and/or any letters patent(s) that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE the entire right, title, and interest in and to said invention(s), said application(s), including any and all nonprovisional application(s) for letters patent claiming priority thereto, and any and all letters patent(s) which may be granted therefor in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisional, reissue, continuation, continuation-in-part, and substitute application(s) thereof, including the right to file any foreign application(s) directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application(s) to which said foreign application(s) are entitled by virtue of international convention, treaty, or otherwise, said invention(s), application(s) and any and all letters patent(s) granted therefor to be held and enjoyed by ASSIGNEE, their successors, and assigns as fully and entirely as same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made;

ASSIGNORS hereby authorize and request the Director of the United States Patent and Trademark Office to issue any and all letters patent(s) on said invention(s) to ASSIGNEE;

ASSIGNORS hereby covenant that no assignment, sale, agreement, or encumbrance has been or will be made which would conflict with this assignment;

ASSIGNORS further transfer and assign to ASSIGNEE all causes of action, rights, and remedies arising under any such application(s) for United States and/or foreign letters patent(s) on said invention(s) prior to, on, or after the effective date of this Assignment; and

ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for any and all application(s) for United States and/or foreign letters patent(s) on said invention(s), for litigation regarding any and all application(s) and/or letters patent(s), and/or for the purpose of protecting title to said invention(s), application(s), and/or letters patent(s) therefor.

ASSIGNORS accept the terms and conditions of the CONFIRMATION/ASSIGNMENT:

F, Kawase 18 March, 2021
Fumiyuki Kawase DATE

I hereby declare that I was personally present and did see ASSIGNOR, who is personally known to me to be the person named above, duly sign and execute this Assignment document on this 18th day of March, 2021, of his/her own free will for the purpose expressed therein at the following location:
Gifu, Japan

WITNESS

Name: Kumiko Takahashi Signature: K. Takahashi

Daiji Kondo
Daiji Kondo

18 March, 2021
DATE

I hereby declare that I was personally present and did see ASSIGNOR, who is personally known to me to be the person named above, duly sign and execute this Assignment document on this 18 day of March, 2021, of his/her own free will for the purpose expressed therein at the following location:
Gifu, Japan

WITNESS

Name: Kumiko Takahashi

Signature: K. Takahashi

ASSIGNEE accepts the terms and conditions of the Assignment:

Taic
NAME: Takahisa Ogawa
TITLE: President
Pacific Engineering Corporation

18 March, 2021
DATE

I hereby declare that I was personally present and did see ASSIGNOR, who is personally known to me to be the person named above, duly sign and execute this Assignment document on this 18 day of March, 2021, of his/her own free will for the purpose expressed therein at the following location:
Gifu, Japan

WITNESS

Name: Kumiko Takahashi

Signature: K. Takahashi